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ABSTRACT OF THE DISCLOSURE

A molding obtained by heating a hydrosilylated polymer at a temperature higher than the softening point or melting point thereof. The hydrosilylated polymer is obtained by reacting at least one hydridosilsesquioxane compound of the following formula (1):

wherein n is an integer of 4-1000, with at least one divinylsiloxane compound of the following formula (2): $CH_2 = CH - SiR_2 - O - (SiR_2 \cdot O)_q - (SiR'_2 \cdot O)_q \cdot - SiR_2 - CH = CH_2$ (2) wherein R and R' are independently selected from alkyl groups, substituted alkyl groups, aryl groups and substituted aryl groups, and q and q' are each an integer of 0 or more.